



Docket No.: M4065.0338/P338-A  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re Patent Application of:  
Richard H. Lane

Application No.: 09/989,372

Art Unit: 2814

Filed: November 21, 2001

Examiner: T. T. Doan

For: ELECTROPOLISHED PATTERNED METAL  
LAYER FOR SEMICONDUCTOR DEVICES

**AMENDMENT**

MS Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated February 19, 2004 (Paper No. 20040211), please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 8 of this paper.